

Glass Passivated Bridge Rectifiers

FEATURES

- Glass passivated junction
- Integrally molded heatsink provide very low thermal resistance for maximum heat dissipation
- Typical I_R less than 0.2μA
- High surge current capability
- UL Recognized File # E-326243
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC


GBPC

GBPC-W

GBPC-M


MECHANICAL DATA

Case: GBPC

GBPC-W: Wire structure

GBPC-M: Terminal cathode parallel to anode

Molding compound, UL flammability classification rating 94V-0

Terminal: Matte tin plated leads, solderable per JESD22-B102

Meet JESD 201 class 1A whisker test

Polarity: Polarity as marked on the body

Mounting torque: 20 in-lbs maximum

Weight: 16.95 g (approximately)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS (T _A =25°C unless otherwise noted)									
PARAMETER	SYMBOL	005	01	02	04	06	08	10	UNIT
Maximum repetitive peak reverse voltage	V _{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V _{RMS}	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	V _{DC}	50	100	200	400	600	800	1000	V
Maximum average forward rectified current GBPC15 GBPC25 GBPC35	I _{F(AV)}	15 25 35							A
Peak forward surge current,8.3 ms single half sine-wave superimposed on rated load (JEDEC method)	I _{FSM}	300 300 400							A
Maximum instantaneous forward voltage drop per element at specified current (Note 1)	V _F	GBPC15 7.5A GBPC25 12.5A GBPC35 17.5A	1.1						V
Maximum reverse current @ Rated VR @ T _J =25°C	I _R	5							μA
Typical thermal resistance	R _{θJC}	1.5							°C/W
Operating junction temperature range	T _J	- 55 to +150							°C
Storage temperature range	T _{STG}	- 55 to +150							°C

Note 1: Pulse test with PW=300μs, 1% duty cycle

ORDERING INFORMATION			
PART NO.	PACKING CODE	PACKAGE	PACKING
GBPC*5xx (Note 1)	T0	GBPC	Tray

Note 1: "*" defines current from 15A (GBPC15xx) to 35A (GBPC35xx),
"xx" defines voltage from 50V (GBPC*5005) to 1000V (GBPC*510)

EXAMPLE			
PREFERRED P/N	PART NO.	PACKING CODE	DESCRIPTION
GBPC1510 T0	GBPC1510	T0	

RATINGS AND CHARACTERISTICS CURVES

($T_A=25^{\circ}\text{C}$ unless otherwise noted)

FIG.1 FORWARD CURRENT DERATING CURVE

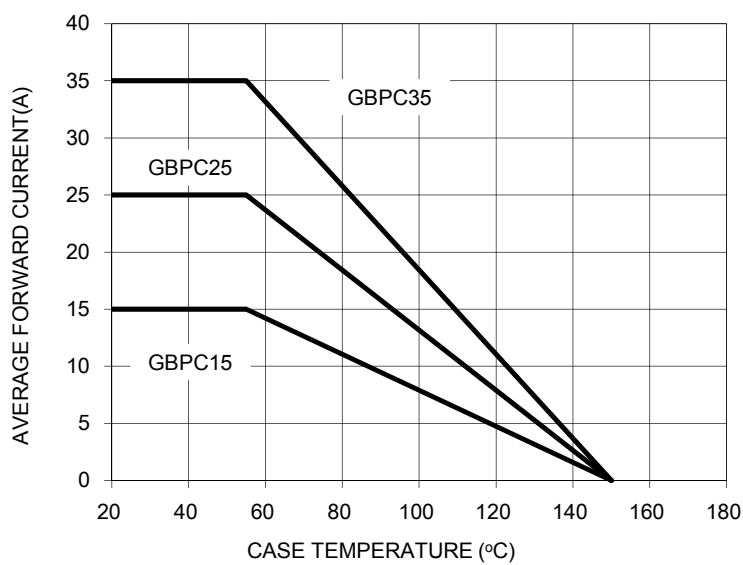


FIG. 2 TYPICAL REVERSE CHARACTERISTICS

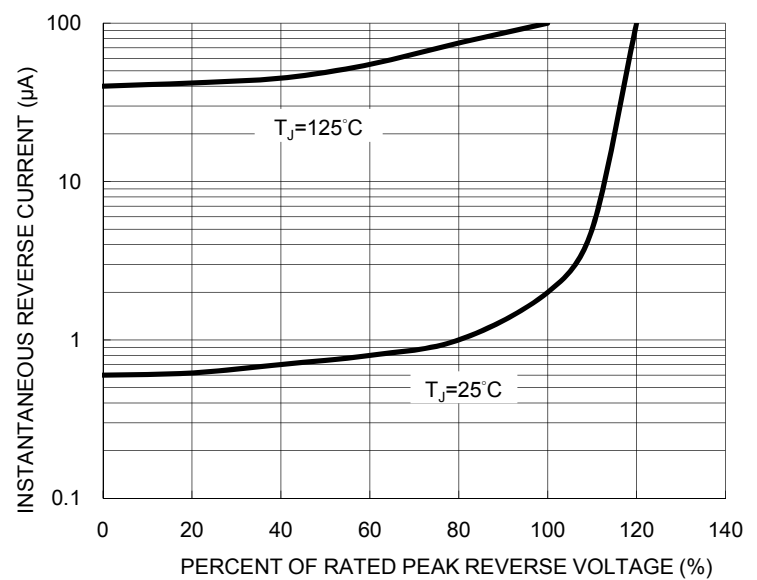


FIG. 3 MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

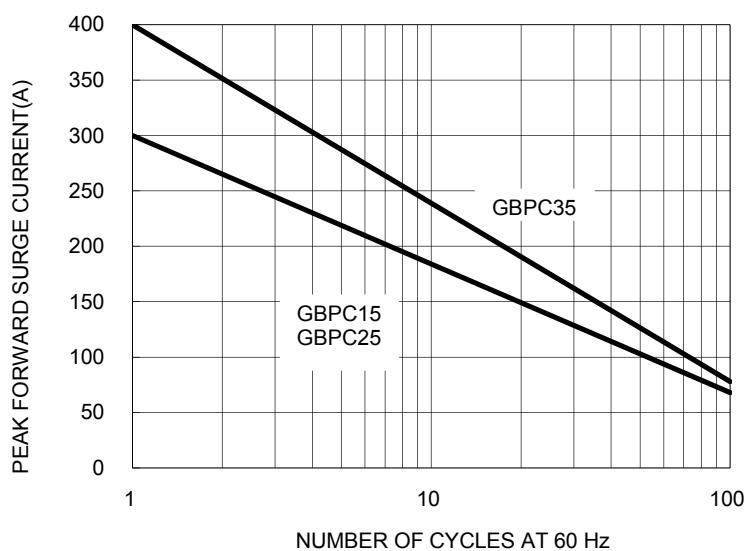


FIG. 4 TYPICAL FORWARD CHARACTERISTICS

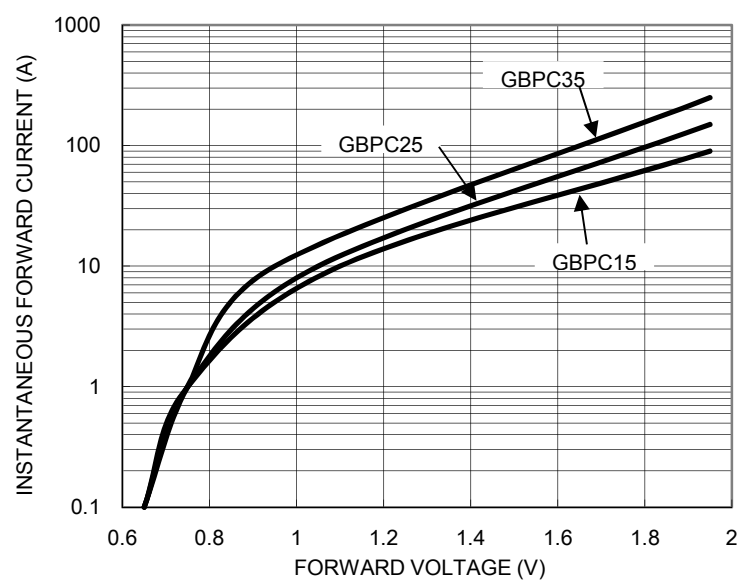
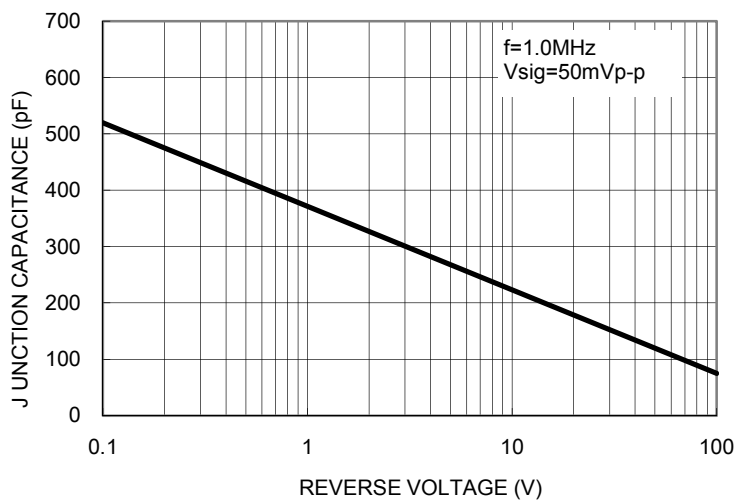
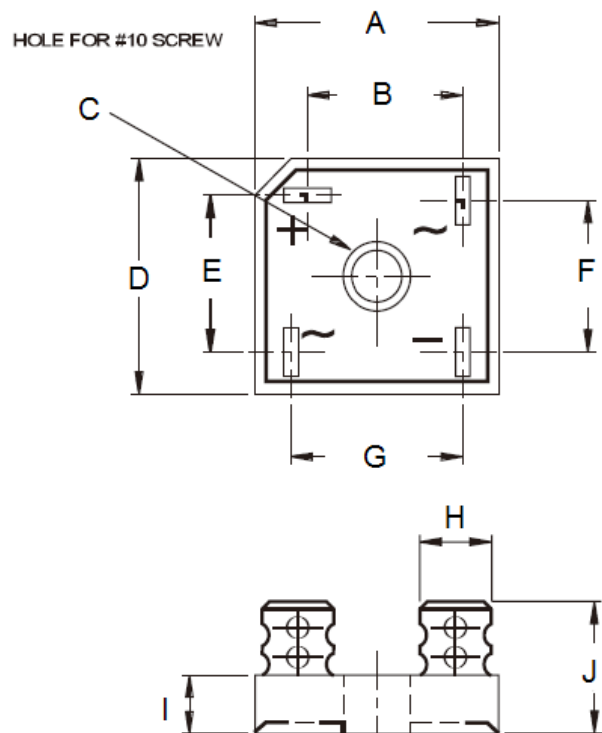


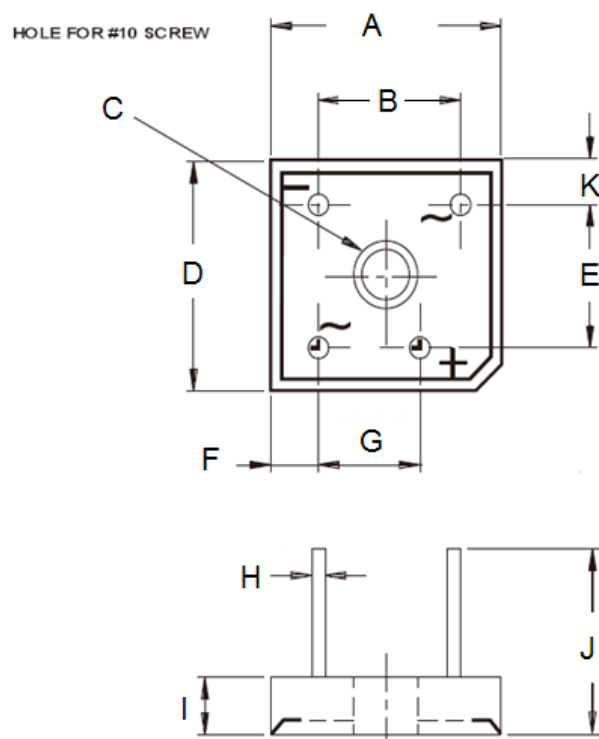
FIG. 5 TYPICAL JUNCTION CAPACITANCE



PACKAGE OUTLINE DIMENSIONS

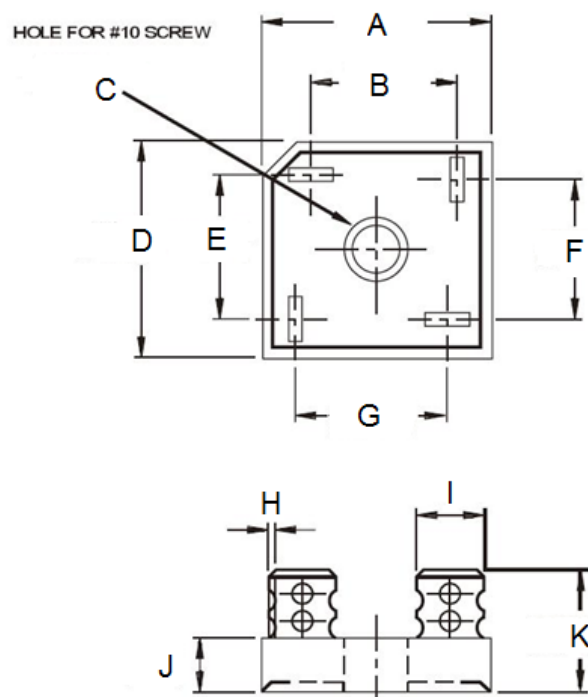


GBPC				
DIM.	Unit (mm)		Unit (inch)	
	Min	Max	Min	Max
A	28.50	29.00	1.122	1.142
B	15.50	17.60	0.610	0.693
C	5.08	5.59	0.200	0.220
D	28.50	29.00	1.122	1.142
E	15.50	17.60	0.610	0.693
F	13.30	15.30	0.524	0.602
G	17.10	19.10	0.673	0.752
H	6.35 (TYP)		0.25 (TYP)	
I	10.97	11.23	0.432	0.442
J	21.50	24.50	0.846	0.965



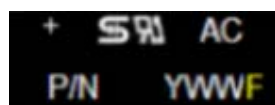
GBPC-W				
DIM.	Unit (mm)		Unit (inch)	
	Min	Max	Min	Max
A	28.50	29.00	1.122	1.142
B	17.10	19.10	0.673	0.752
C	5.08	5.59	0.200	0.220
D	28.50	29.00	1.122	1.142
E	17.10	19.10	0.673	0.752
F	4.40	6.20	0.173	0.244
G	10.40	12.40	0.409	0.488
H	0.97	1.07	0.038	0.042
I	10.97	11.23	0.432	0.442
J	30.50	-	1.201	-
K	4.40	6.20	0.173	0.244

PACKAGE OUTLINE DIMENSIONS



GBPC-M				
DIM.	Unit (mm)		Unit (inch)	
	Min	Max	Min	Max
A	28.50	29.00	1.122	1.142
B	15.50	17.60	0.610	0.693
C	5.08	5.59	0.200	0.220
D	28.50	29.00	1.122	1.142
E	15.50	17.60	0.610	0.693
F	15.50	17.60	0.610	0.693
G	15.50	17.60	0.610	0.693
H	0.76	0.86	0.030	0.034
I	6.6 (TYP)		0.26 (TYP)	
J	10.97	11.23	0.432	0.442
K	21.26	24.57	0.837	0.967

MARKING DIAGRAM



P/N = Specific Device Code
YWW = Date Code
F = Factory Code

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